

<b>FIELD INSPECTION REPORT</b> Quality Control Form				ITP No.:				
				Inspection Gr.				
				Report No.				
				Date				
<b>CHIPPING &amp; PADDING INSPECTION FOR STRUCTURE</b>								
NO	Column No	Dimension	Condition		Elevation		Difference	Remarks
			Chip	Pad	Design	Actual		
1.								
2.								
3.								
4.								
5.								
6.								
7.								
8.								
9.								
10.								
11.								
12.								
13.								
14.								
15.								
16.								
17.								
18.								
19.								
20.								
SUBCON. QC			CONTRACTOR/TPI			COMPANY		
DATE:			DATE:			DATE:		
NOTE:								

Legend ACC:ACCEPT      NA.: Not Applicable      REJ: REJECT